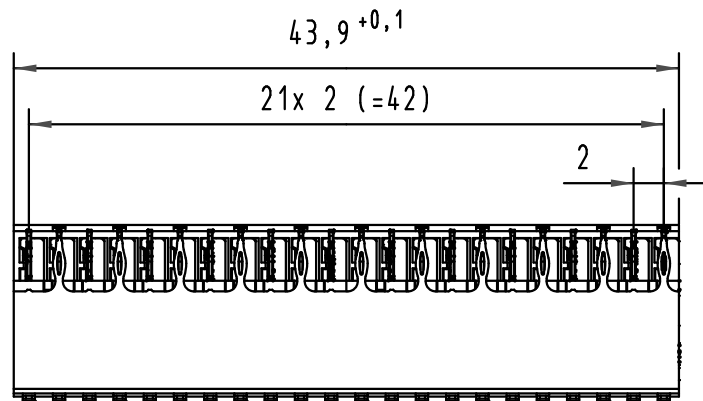
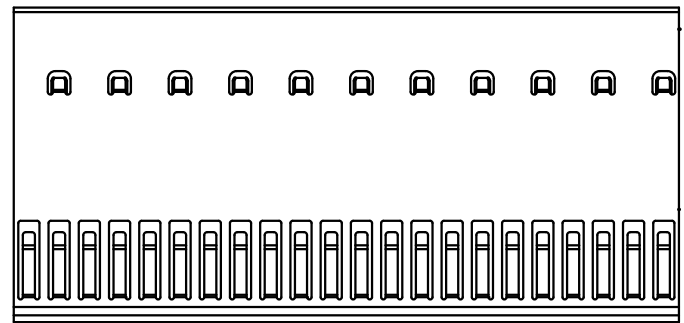
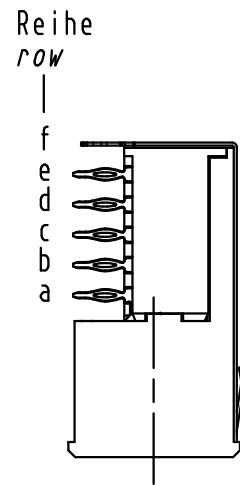
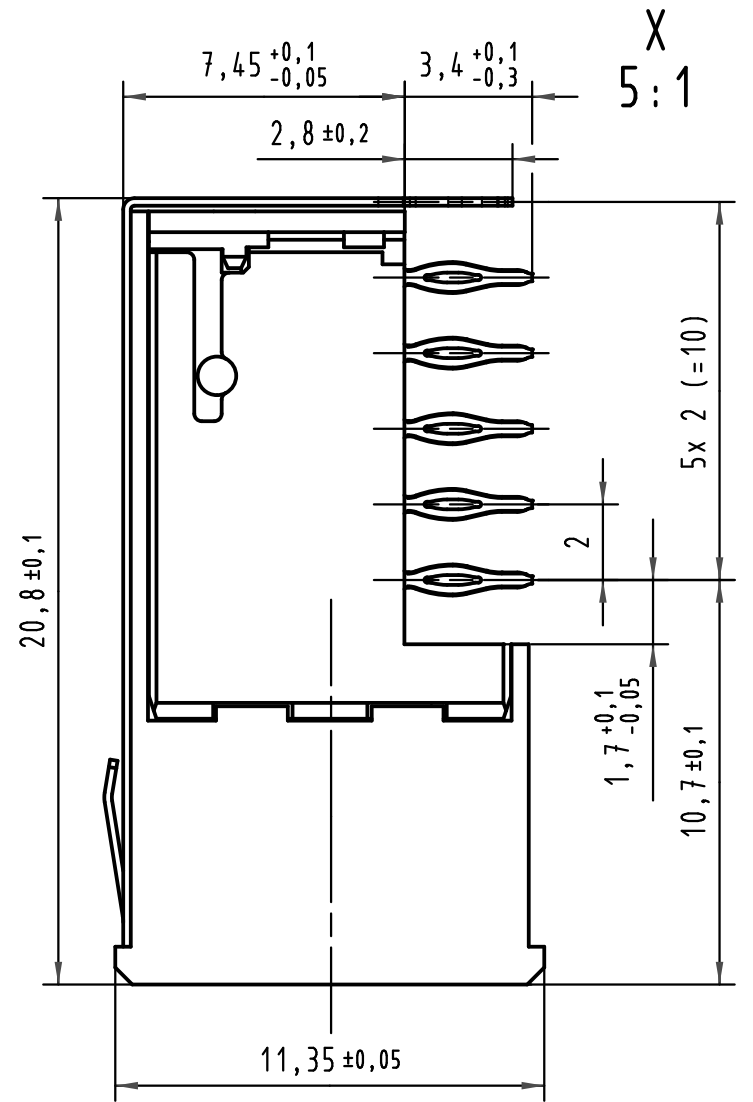
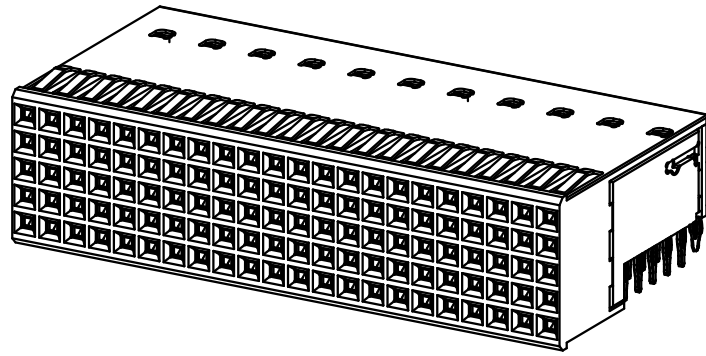
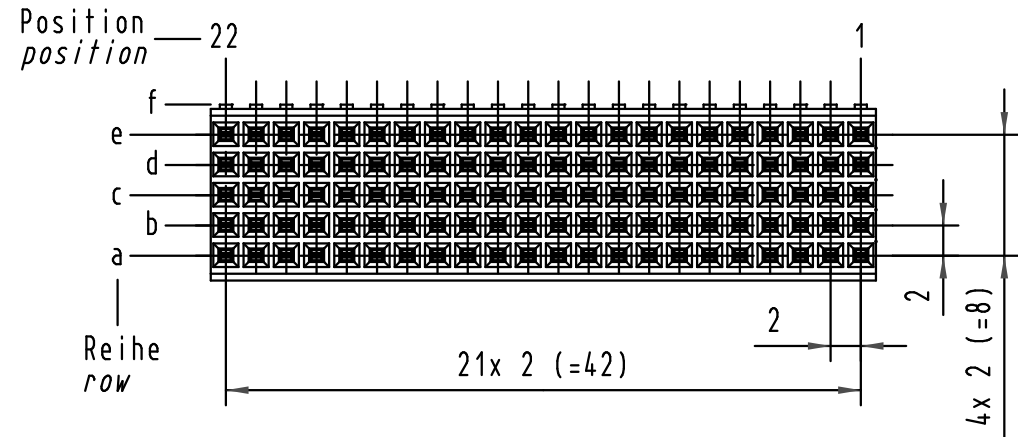
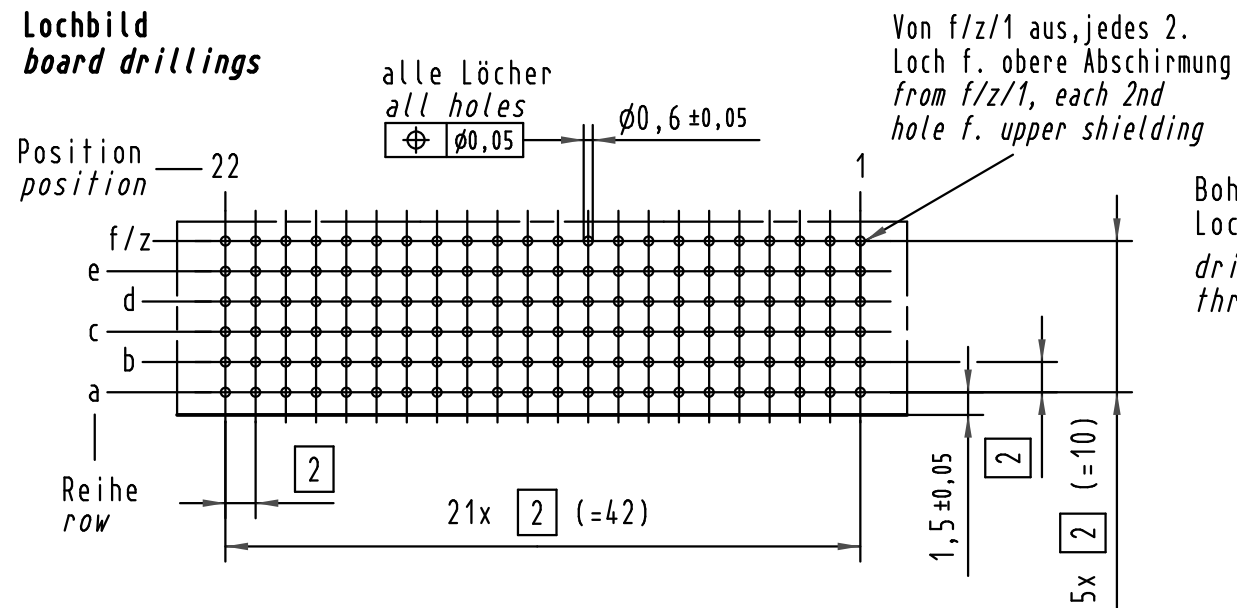


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**Lochbild
 board drillings**



Bohrlochdurchmesser: ∅0,7±0,02 mm
 Lochdurchmesser (mit Oberfläche): ∅0,6±0,05 mm
 drill hole dia.: ∅0,7±0,02 mm
 through hole dia. (after plating): ∅0,6±0,05 mm

17 24 110 4102	—	min.0,76µm (30µm) Au über/over min.1,27µm (50µm) Ni
17 24 110 2102	2	Au über/over Ni
17 24 110 1102	1	Au über/over Ni
Bestell-Nr. part-No.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maß/Free size tolerances IEC 61076-4-101		
				Dat.	Name	Maßstab/Scale		
35456	01.12.08	TD	Detail.	30.06.99	Hm	2:1 (5:1)		
32387	18.11.04	HL.	Insp.	30.06.99	Ko			
29412	07.05.01	Lk	Stand.					
28494	20.09.00	Koe	HARTING Electronics GmbH & Co. KG			har-bus HM Federleiste, Typ B-22, 110 pol. mit Schirmblech Reihe-f har-bus HM female connector, type B-22, 110 pol. with shield row-f		
25016			D-32339 ESPELKAMP					
Mod.	Dat.	Name				TB 17 24 110 x102		Blatt/ page
						Sub.		